L Number	Hits	Search Text	DB	Time stamp
1	473368	die	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/22 08:27
2	11617	cyanoacrylate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/22 08:27
3	553	super near5 glue	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/22 08:27
4	12016	cyanoacrylate or (super near5 glue)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/22 08:27
5	114	die same (cyanoacrylate or (super near5 glue))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/22 08:30
6	1402658	lead or leadframe	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/22 08:27
7	66332	lead near3 frame	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/22 08:27
8	1402658	(lead or leadframe) or (lead near3 frame)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/22 08:27
9	20	((lead or leadframe) or (lead near3 frame)) same (die same (cyanoacrylate or (super near5 glue)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/22 08:28
10	631929	chip	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/22 08:31
11	90	chip same (cyanoacrylate or (super near5 glue))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/22 08:31

L Number	Hits	Search Text	DB	Time stamp
1	33337	anaerobic	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/22 09:41
2	1049990	chip or die	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/22 09:41
3	69243	leadframe or lead near3 frame	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/22 09:41
4	7	anaerobic same (chip or die) same (leadframe or lead near3 frame)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/22 09:43
5	352	anaerobic same (chip or die)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/22 09:44
6	570606	paackaging or package or packaged	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/22 09:44
7	69	(anaerobic same (chip or die)) and (paackaging or package or packaged)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/22 09:46
8	1397644	semiconductor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/22 09:46
9	40	semiconductor and (anaerobic same (chip or die))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/22 09:47